



- NOTES:
- MATERIAL**
Housing: LCP, BLACK, UL 94V-0
Contact: Phosphorbronze, t=0.15mm
Shell: Stainless steel t=0.20mm
 - FINISH**
Contact: 50u" Ni min Plating over all
Gold flash over all
Shell: Selective Gold Flash in Solder Tail Area
50u" Ni min Plating over all
 - All Dimensions Marked **(XX)** Must be Controlled By QC.
 - ALL DIMENSIONS MARKED **(XX)** MUST BE MEASURED BY FAI.
 - GP PASSED ACCORD WITH HRD-ROHS-219 STANDARD.

RECOMMENDED P.C.B LAYOUT
TOLERANCE: ±0.05MM

T-card	pin NO.	pin name
	T1	DAT2
	T2	CD/DAT3
	T3	CMD
	T4	VDD
	T5	CLK
	T6	VSS
	T7	DAT0
	T8	DAT1
SIMCARD TERMINAL NO.	PIN NO.	
	P1	VCC
	P2	RST
	P3	CLK
	P4	reserved
	P5	GND
	P6	VPP
	P7	I/O
	P8	reserved

REV.	ECN NO.	DESCRIPTION	DATE	REV.	FINISH:				
G	E1912710A	锡脚加胶	12/09/2019	A	SEE NOTE				
F	E1606214A	修改图面与实物一致	06/14/2016						
E	E120137A	铁壳外形变更	11/09/2012						
D	E120115A	铁壳外形变更	09/19/2012						

UNITS:	GENERAL TOLERANCE		DRAW:	PART NO:
mm	X. ±0.25	X.° ±2.00°		S19-0B20F36A
DATE:	.X ±0.20	.X° ±1.00°	CHECKED:	TITLE: SIM CARD & T-FLASH CARD
10/27/2011	.XX ±0.10	.XX° ±0.50°	APPROVE:	H=3.65MM 防溃pin结构
SCALE:	.XXX ±0.05	.XXX° ±0.10°		DRAWING NO:
2:1				
SHEET:	MATERIAL:			
1/1				

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